

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Complementary ThermalTrak™ Transistors

The ThermalTrak family of devices has been designed to eliminate thermal equilibrium lag time and bias trimming in audio amplifier applications. They can also be used in other applications as transistor die protection devices.

Features

- Thermally Matched Bias Diode
- Instant Thermal Bias Tracking
- Absolute Thermal Integrity
- High Safe Operating Area
- Pb-Free Packages are Available*

Benefits

- Eliminates Thermal Equilibrium Lag Time and Bias Trimming
- Superior Sound Quality Through Improved Dynamic Temperature Response
- Significantly Improved Bias Stability
- Simplified Assembly
 - Reduced Labor Costs
 - Reduced Component Count
- High Reliability

Applications

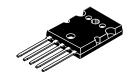
- High-End Consumer Audio Products
 - Home Amplifiers
 - Home Receivers
- Professional Audio Amplifiers
 - ◆ Theater and Stadium Sound Systems
 - Public Address Systems (PAs)



ON Semiconductor®

http://onsemi.com

BIPOLAR POWER TRANSISTORS 15 AMP, 260 VOLT, 180 WATT

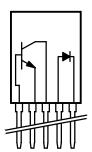


TO-264, 5 LEAD CASE 340AA STYLE 1

MARKING DIAGRAM

SCHEMATIC





NJL0xxxD = Device Code

xxx = 281 or 302

G = Pb-Free Package A = Assembly Location

YY = Year

WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NJL0281D	TO-264	25 Units / Rail
NJL0281DG	TO-264 (Pb-Free)	25 Units / Rail
NJL0302D	TO-264	25 Units / Rail
NJL0302DG	TO-264 (Pb-Free)	25 Units / Rail

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO}	260	Vdc
Collector-Base Voltage	V _{CBO}	260	Vdc
Emitter-Base Voltage	V _{EBO}	5	Vdc
Collector–Emitter Voltage – 1.5 V	V _{CEX}	260	Vdc
Collector Current – Continuous – Peak (Note 1)	I _C	15 25	Adc
Base Current – Continuous	I _B	1.5	Adc
Total Power Dissipation @ T _C = 25°C Derate Above 25°C	P _D	180 1.43	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	- 65 to +150	°C
DC Blocking Voltage	V _R	200	V
Average Rectified Forward Current	I _{F(AV)}	1.0	Α

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.694	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle < 10%.

ATTRIBUTES

Chara	Value		
ESD Protection	Human Body Model Machine Model	>8000 V > 400 V	
Flammability Rating		UL 94 V-0 @ 0.125 in	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	•	.1		1
Collector–Emitter Sustaining Voltage $(I_C = 100 \text{ mAdc}, I_B = 0)$	V _{CEO(sus)}	260	_	Vdc
Collector Cutoff Current $(V_{CB} = 260 \text{ Vdc}, I_E = 0)$	I _{CBO}	-	10	μAdc
Emitter Cutoff Current $(V_{EB} = 5 \text{ Vdc}, I_C = 0)$	I _{EBO}	-	5	μAdc
ON CHARACTERISTICS			•	
DC Current Gain $ \begin{array}{l} (I_C=500 \text{ mAdc, } V_{CE}=5 \text{ Vdc}) \\ (I_C=1 \text{ Adc, } V_{CE}=5 \text{ Vdc}) \\ (I_C=3 \text{ Adc, } V_{CE}=5 \text{ Vdc}) \end{array} $	h _{FE}	75 75 75	150 150 150	
	V _{CE(sat)}	-	1.0	Vdc
Base–Emitter On Voltage ($I_C = 5$ Adc, $V_{CE} = 5$ Vdc)	V _{CE(on)}	-	1.2	Vdc
DYNAMIC CHARACTERISTICS			•	
$\begin{aligned} & \text{Current-Gain - Bandwidth Product} \\ & (I_C = 1 \text{ Adc, } V_{CE} = 5 \text{ Vdc, } f_{test} = 1 \text{ MHz}) \end{aligned}$	f _⊤	30	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1 MHz)	C _{ob}	-	400	pF
Maximum Instantaneous Forward Voltage (Note 2) $(i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C})$ $(i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C})$	VF	1.1 0.93		V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 150^{\circ}C$)	İR	i _R 11		μΑ
Maximum Reverse Recovery Time $(i_F = 1.0 \text{ A, di/dt} = 50 \text{ A/µs})$	t _{rr}	1	00	ns

^{2.} Diode Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

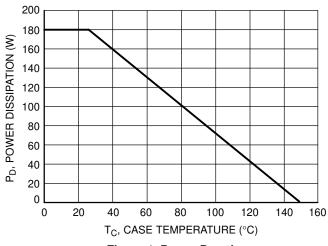


Figure 1. Power Derating

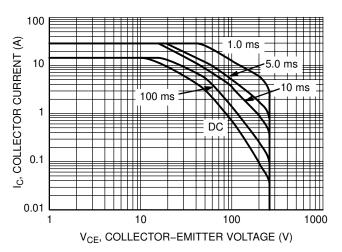


Figure 2. Safe Operating Area

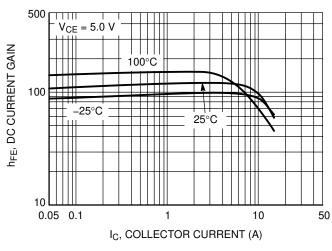


Figure 3. NJL0281A DC Current Gain

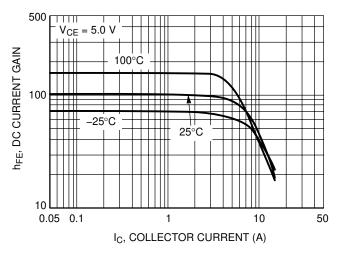


Figure 4. NJL0302A DC Current Gain

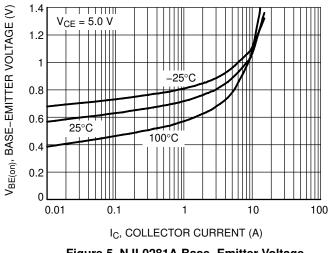


Figure 5. NJL0281A Base-Emitter Voltage

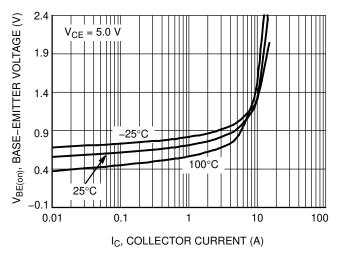


Figure 6. NJL0302A Base-Emitter Voltage

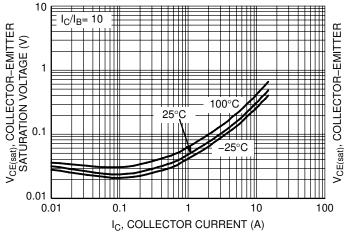


Figure 7. NJL0281A Saturation Voltage

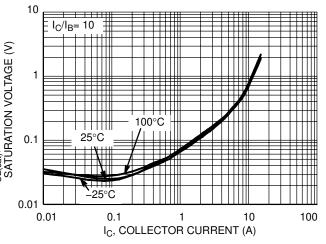


Figure 8. NJL0302A Saturation Voltage

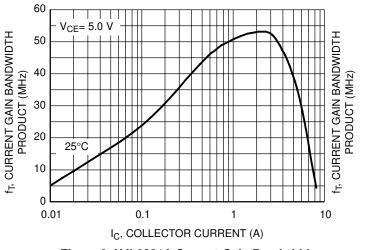


Figure 9. NJL0281A Current Gain Bandwidth Product

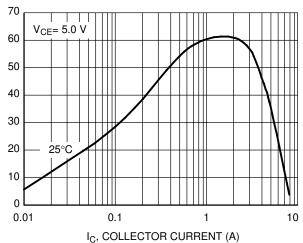


Figure 10. NJL0302A Current Gain Bandwidth Product

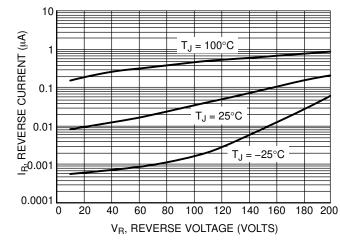


Figure 11. Typical Reverse Current

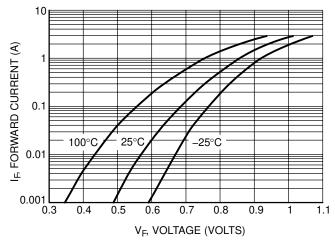
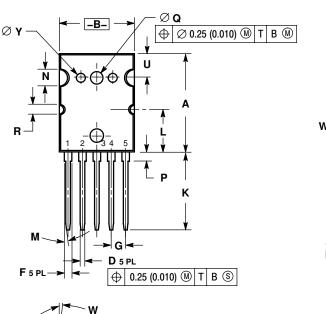
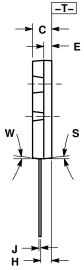


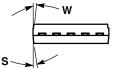
Figure 12. Typical Forward Voltage

PACKAGE DIMENSIONS

TO-264, 5 LEAD CASE 340AA-01 **ISSUE O**







- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
- CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	25.857	25.984	26.111	1.018	1.023	1.028
В	19.761	19.888	20.015	0.778	0.783	0.788
С	4.928	5.055	5.182	0.194	0.199	0.204
D	1.	219 BS	0	0.	0480 BS	SC SC
Е	2.032	2.108	2.184	0.0800	0.0830	0.0860
F	1.	981 BS	0	0.0780 BSC		
G	3	.81 BSC	;	0.150 BSC		
Н	2.667	2.718	2.769	0.1050	0.1070	0.1090
J	C	.584 BS	C	0.0230 BSC		SC
K	20.422	20.549	20.676	0.804 0.809 0.81		0.814
L	1	11.28 REF		0.444 REF		F
М	0 °		7 °	0 °		7 °
N		4.57 REF		0.180 REF		EF
Р	2.259	2.386	2.513	0.0889	0.0939	0.0989
Q	3.480 BSC			0.1370 BSC		SC
R		2.54 REF 0.100 REF		ΞF		
S	0 °		8°	0 °		8 °
U	6.17 REF		0.243 REF			
W	0 °		6°	0 °		6°
Υ	2.388 BSC			0.0940 BSC		

STYLE 1:

PIN 1. BASE 2. EMITTER

- 3. COLLECTOR 4. ANODE
- CATHODE

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